

**FAIRCHILD**

A Schlumberger Company

**2N6759/2N6760**  
**N-Channel Power MOSFETs,**  
**5.5 A, 350 V/400 V**

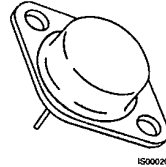
Power And Discrete Division

T-39-11

**Description**

These devices are n-channel, enhancement mode, power MOSFETs designed especially for high voltage, high speed applications, such as off-line switching power supplies, UPS, AC and DC motor controls, relay and solenoid drivers.

TO-204AA

2N6759  
2N6760

- $V_{GS}$  Rated at  $\pm 20$  V
- Silicon Gate for Fast Switching Speeds
- $I_{DSS}$ ,  $R_{DS(on)}$ , Specified at Elevated Temperature
- Rugged
- Low Drive Requirements
- Ease of Paralleling

**Maximum Ratings**

Symbol	Characteristic	Rating 2N6760	Rating 2N6759	Unit
$V_{DSS}$	Drain to Source Voltage	400	350	V
$V_{DGR}$	Drain to Gate Voltage $R_{GS} = 1.0 \text{ M}\Omega$	400	350	V
$V_{GS}$	Gate to Source Voltage	$\pm 20$	$\pm 20$	V
$T_J$ , $T_{stg}$	Operating Junction and Storage Temperatures	-55 to +150	-55 to +150	$^{\circ}\text{C}$
$T_L$	Maximum Lead Temperature for Soldering Purposes, 1/16" From Case for 10 s	300	300	$^{\circ}\text{C}$

**Maximum On-State Characteristics**

$R_{DS(on)}$	Static Drain-to-Source On Resistance	1.0	1.5	$\Omega$
$I_D$	Drain Current Continuous at $T_C = 25^{\circ}\text{C}$ Continuous at $T_C = 100^{\circ}\text{C}$	5.5 3.5	4.5 3.0	A
$I_{DM}$	Pulsed	8.0 <sup>2</sup>	7.0 <sup>2</sup>	

**Maximum Thermal Characteristics**

$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.67	1.67	$^{\circ}\text{C}/\text{W}$
$P_D$	Total Power Dissipation at $T_C = 25^{\circ}\text{C}$ at $T_C = 100^{\circ}\text{C}$	75 30	75 30	W
	Linear Derating Factor	0.6	0.6	W/ $^{\circ}\text{C}$

**Notes**

All values are JEDEC registered except as noted. For information concerning connection diagram and package outline, refer to Section 7.

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**Electrical Characteristics** ( $T_C = 25^\circ\text{C}$  unless otherwise noted)

Symbol	Characteristic	Min	Max	Unit	Test Conditions		
<b>Off Characteristics</b>							
$V_{(BR)DSS}$	Drain Source Breakdown Voltage <sup>1</sup>			V	$V_{GS} = 0\text{ V}, I_D = 1.0\text{ mA}$		
	2N6760	400 <sup>2</sup>					
	2N6759	350 <sup>2</sup>					
$I_{DSS}$	Zero Gate Voltage Drain Current		1	mA	$V_{DS} = \text{Rated } V_{DSS}, V_{GS} = 0\text{ V}$		
			4				
$I_{GSS}$	Gate-Body Leakage Current		$\pm 100$	nA	$V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$		
<b>On Characteristics</b>							
$V_{GS(th)}$	Gate Threshold Voltage	2.0	4.0	V	$I_D = 1.0\text{ mA}, V_{DS} = V_{GS}$		
$R_{DS(on)}$	Static Drain-Source On-Resistance <sup>1</sup>			$\Omega$	$V_{GS} = 10\text{ V}$		
		2N6760				1.0	$I_D = 3.0\text{ A}$
		2N6759				1.5	$I_D = 3.5\text{ A}$
		2N6760				2.2	$I_D = 3.5\text{ A}, T_C = 125^\circ\text{C}$
		2N6759				3.3	$I_D = 3.0\text{ A}, T_C = 125^\circ\text{C}$
$V_{DS(on)}$	Drain-Source On-Voltage <sup>1</sup>		6.7	V	$V_{GS} = 10\text{ V}; I_D = 5.5\text{ A}$		
			7.0		$V_{GS} = 10\text{ V}; I_D = 4.5\text{ A};$		
$g_{fs}$	Forward Transconductance <sup>1</sup>	3.0	9.0	S ( $\Omega$ )	$V_{DS} = 15\text{ V}, I_D = 3.5\text{ A}$		
<b>Dynamic Characteristics</b>							
$C_{iss}$	Input Capacitance	350	800	pF	$V_{DS} = 25\text{ V}, V_{GS} = 0\text{ V}$ $f = 1.0\text{ MHz}$		
$C_{oss}$	Output Capacitance	50	300	pF			
$C_{rss}$	Reverse Transfer Capacitance	20	80	pF			
<b>Switching Characteristics</b> ( $T_C = 25^\circ\text{C}$ , Figures 9, 10)							
$t_{d(on)}$	Turn-On Delay Time		30	ns	$V_{DD} = 175\text{ V}, I_D = 3.5\text{ A}$ $V_{GS} = 10\text{ V}, R_{GEN} = 15\ \Omega$ $R_{GS} = 15\ \Omega$		
$t_r$	Rise Time		35	ns			
$t_{d(off)}$	Turn-Off Delay Time		55	ns			
$t_f$	Fall Time		55	ns			
$Q_g$	Total Gate Charge		30 <sup>2</sup>	nC	$V_{GS} = 10\text{ V}, I_D = 7.0\text{ A}$ $V_{DD} = 180\text{ V}$		

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Electrical Characteristics (Cont.) ( $T_C = 25^\circ\text{C}$  unless otherwise noted)

Symbol	Characteristic	Min	Typ	Max	Unit	Test Conditions
<b>Source-Drain Diode Characteristics</b>						
$I_S$	Continuous Source Current 2N6760 2N6759			5.5 4.5	A	
$I_{SM}$	Pulsed Source Current 2N6760 2N6759			8.0 7.0	A	
$V_{SD}$	Diode Forward Voltage 2N6760 2N6759	0.75		1.5	V	$I_S = 5.5 \text{ A}; V_{GS} = 0 \text{ V}$
		0.70		1.4		$I_S = 4.5 \text{ A}; V_{GS} = 0 \text{ V}$
$t_{rr}$	Reverse Recovery Time		550 <sup>2</sup>		ns	$V_{GS} = 0 \text{ V}, T_J = 150^\circ\text{C}$ $I_F = I_{SM}, di_F/dt = 100 \text{ A}/\mu\text{S}$
$Q_{RR}$	Reverse Recovery Charge		8.0 <sup>2</sup>		$\mu\text{C}$	$V_{GS} = 0 \text{ V}, T_J = 150^\circ\text{C}$ $I_F = I_{SM}, di_F/dt = 100 \text{ A}/\mu\text{S}$

Notes

1. Pulse test: Pulse width  $\leq 300 \mu\text{s}$ , Duty cycle  $\leq 2\%$
2. Non-JEDEC registered value.

Typical Performance Curves

Figure 1 Output Characteristics

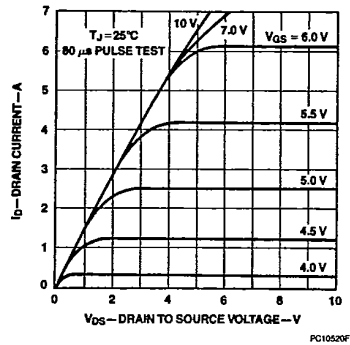
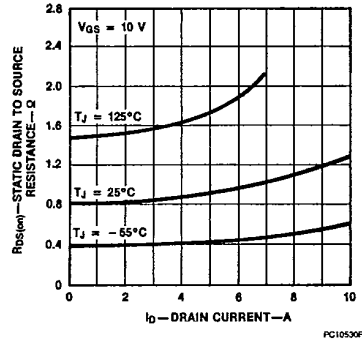


Figure 2 Static Drain to Source Resistance vs Drain Current



Typical Performance Curves (Cont.)

Figure 3 Transfer Characteristics

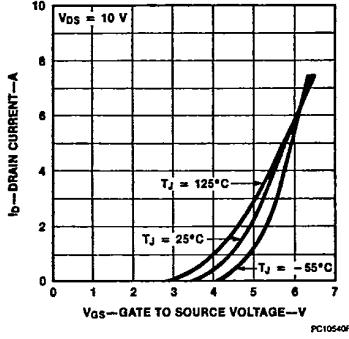


Figure 4 Temperature Variation of Gate to Source Threshold Voltage

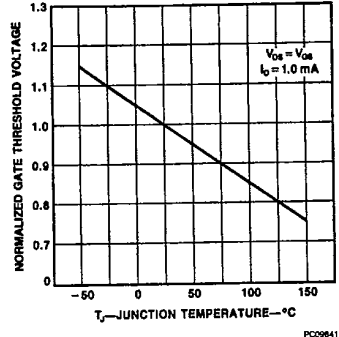


Figure 5 Capacitance vs Drain to Source Voltage

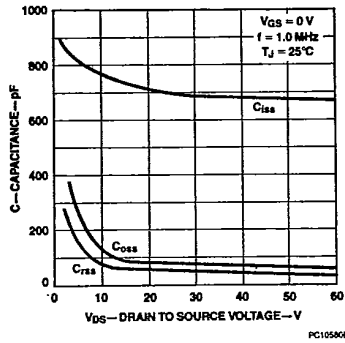


Figure 6 Gate to Source Voltage vs Total Gate Charge

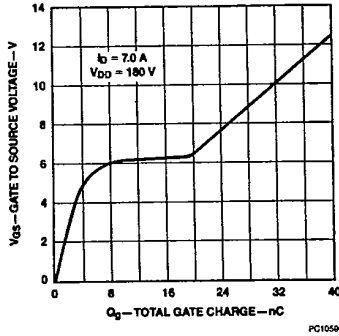


Figure 7 Forward Biased Safe Operating Area

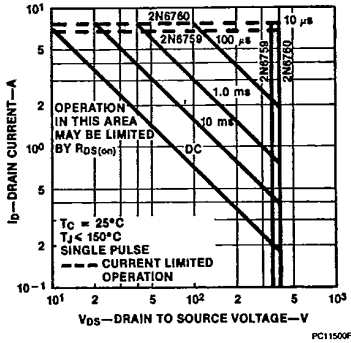
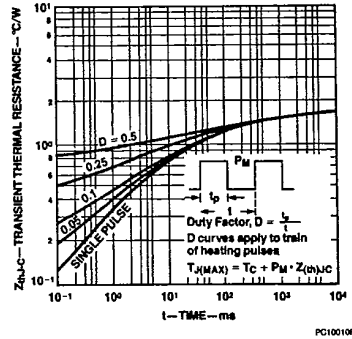


Figure 8 Transient Thermal Resistance vs Time



Typical Electrical Characteristics

Figure 9 Switching Test Circuit

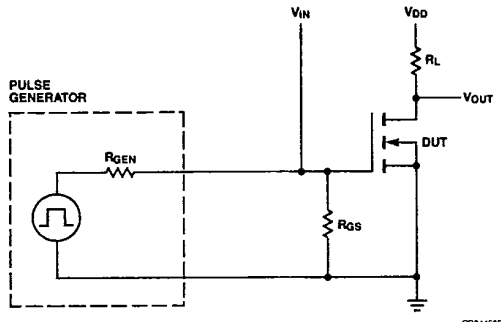
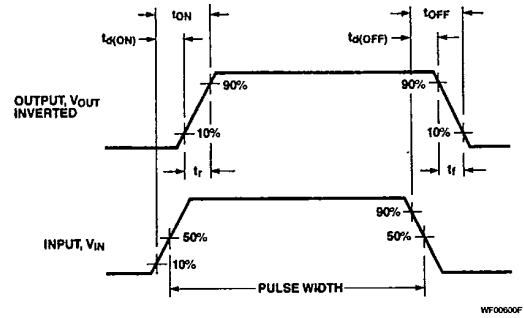


Figure 10 Switching Waveforms



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